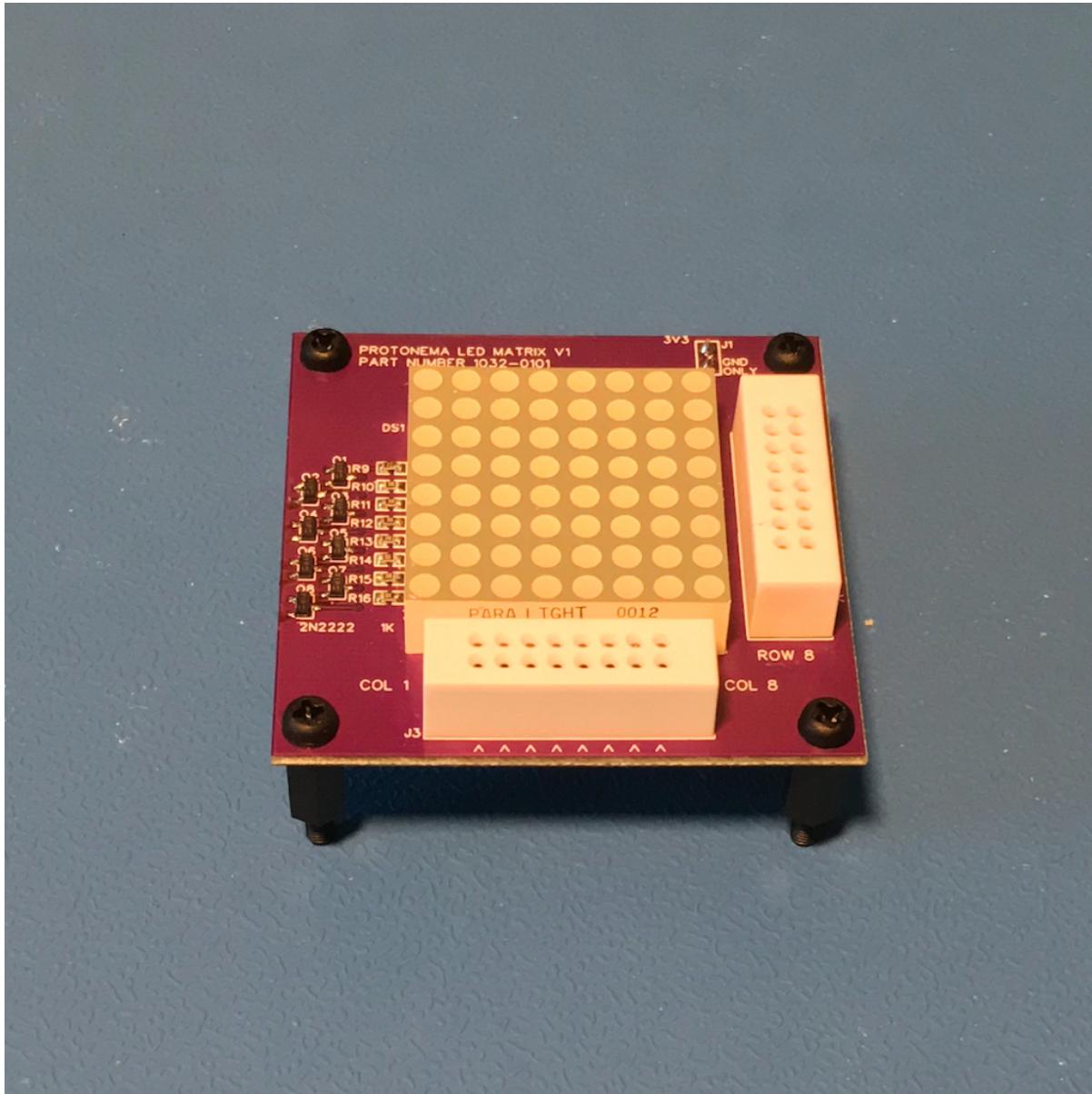


1

# ASSEMBLY INSTRUCTIONS

2

3 1032A LED Matrix Stamp



5 Document control number: 1032-8010

6 Document date: 2022-12-08

7 Document revision: 1.0.0-draft.2

8 ABSTRACT: This document provides instructions on how to assemble and test a 1032A LED matrix stamp. A  
9 complete bill of materials is included as an annex.

10 Suggestions and corrections should be directed to <http://www.github.com/dslik/protonema/issues>

11 Serial number: Assembly date: Assembled by:

12 USAGE

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21 Source location: <https://github.com/dslik/protonema/tree/main/stamps/1032A>

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24 "Based on the Protonema Electronics Prototyping and Learning System by David Slik -  
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51 Revision history

Table 1: Document Revisions

Version	Date	Change	Approver
1.0.0-draft.1	2022-12-04	Initial draft	D. Slik
1.0.0-draft.2	2022-12-08	Added missing RoHS certificate	D. Slik

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188

## Part I

189

# 1032A assembly instructions

190 **Section 1**

191 **Overview**

192 This document describes the materials, processes, outcomes and verifications required to successfully assem-  
193 ble and test a 1032A LED matrix stamp, a sub-component of the Protonema electronics prototyping and learning  
194 system.

195 A first-time reader should carefully review section 2 - prerequisites, and section 3 - preparation before beginning  
196 the assembly process.

197 This document serves both as instructions and as a record of the assembly of the product. When you finish each  
198 step in this document, sign your name (or apply your stamp) in the "Signature/Stamp" box on the right to provide a  
199 record of completion.

200 When things go wrong, this document provides guidance for common issues that have been encountered in the  
201 past. When this document does not provide guidance, please contact your quality management representative,  
202 who will help you fill out an exception report. These reports help improve process quality and product quality, and  
203 these reports are incorporated into future revisions of this document.

204 Always remember: If you are unable to successfully complete these instructions, that means the processes sup-  
205 porting you (including this document) have failed you. Our processes are built for your success, and by improving  
206 our processes, we help everyone succeed.

## **207 Section 2**

# **208 Prerequisites**

### **209 2.1 Required safety training**

- 210** The following safety training units must be completed before assembling this product.  
**211** By signing (or applying your stamp) on the right, you indicate that you have completed the following training:

Table 2: Safety training

Item #	Description	Signature/Stamp
1	0102-0100 - Safety reporting policies and procedures training  Key topics: Understanding policies and procedures around how to identify, contain and report a safety-related issue in the workplace, including damaged or malfunctioning equipment, leaks, spills, and other occupational hazards.	Stamp or sign here
2	0102-0101 - Material safety data sheets training  Key topics: Understanding how to read material safety data sheets (MSDS) for materials you will be handling during product assembly, how they can affect your health and the health of the environment, how to safely handle and dispose of them, and what to do if there is a spill or accidental exposure.	Stamp or sign here
3	0102-0102 - Solder handling and disposal policies and procedures training  Key topics: Understanding policies and procedures related to handling solder and solder paste, stencil cleaning, and solder disposal.	Stamp or sign here
4	0102-0105 - Electro-static discharge controls policies and procedures training  Key topics: Understanding policies and procedures related to protecting equipment and components from electro-static discharge, including clothing, protective equipment, material handling and labelling.	Stamp or sign here

## 2.2 Required skills training

- <sup>212</sup> The following skills training units must be completed before assembling this product.  
<sup>214</sup> By signing (or applying your stamp) on the right, you indicate that you have completed the following training:

Table 3: Skills training

Item #	Description	Signature/Stamp
1	0103-0202 - ANSI/ESD S20.20 Electro-static discharge controls  Key topics: Understanding of ESD safety, the ESD control program, equipment and personnel grounding, EPAs, packaging and marking.	Stamp or sign here
2	0103-0203 - General components handling  Key topics: Understanding of safe component handling, including reeled components, components in JEDEC trays, and loose components. Includes avoiding contamination, moisture control, and component inventory management.	Stamp or sign here
3	0103-0414 - 5040-XTS reflow station  Key topics: Safe and effective use of the 5040-XTS reflow station, including use of the pre-heater, the hot air system, and the soldering iron. Covers inspection and verification, cleaning, preferred settings and best practice techniques.	Stamp or sign here
4	0103-0301 - IPC-A-610G - Acceptability of electronic assemblies  Key topics: Covers visual acceptability requirements for electronic assemblies, including handling considerations, hardware installation, component placement, soldering, terminal connections, wiring, marking and cleanliness.	Stamp or sign here
5	0103-0302 - IPC-J-STD-001F - Soldered electrical connections  Key topics: Covers soldering materials, general soldering and assembly requirements, wire and terminal connections, through-hole mounting, surface mounting of components, cleaning process requirements, PCB requirements, coatings and product assurance.	Stamp or sign here

## **215 Section 3**

# **216 Preparation**

### **217 3.1 Workspace**

- 218 Before starting assembly, check out an assembly desk for a minimum of one hour. Units are assembled in batches of four, with each batch taking 20 minutes.**

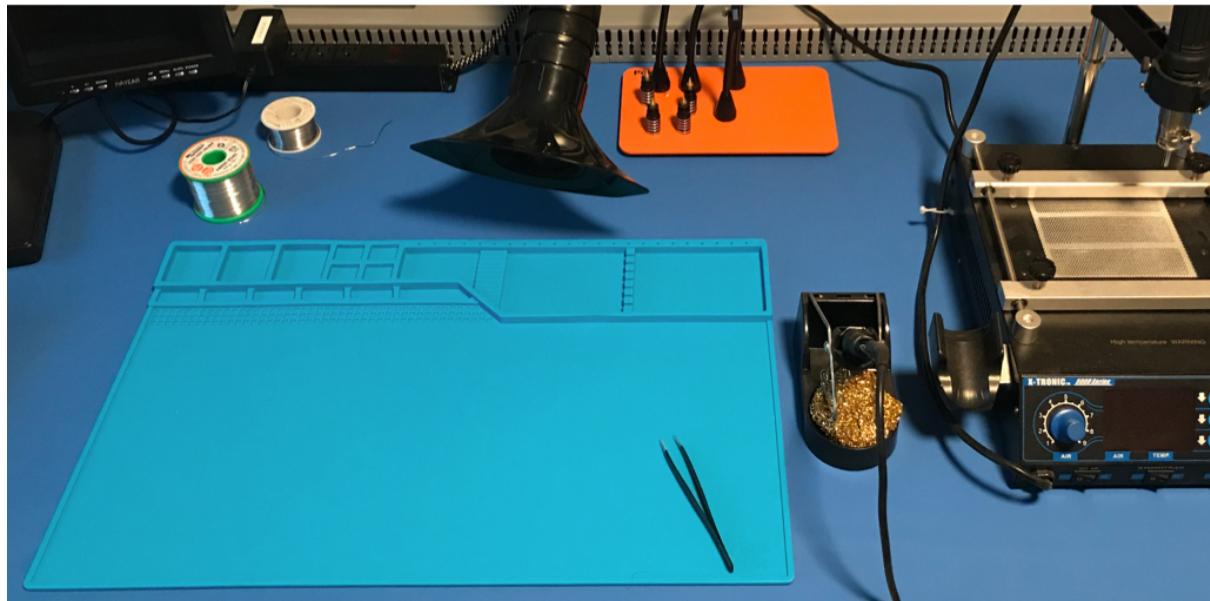


Fig. 1: Assembly Desk

Table 4: Prepare workspace

Step	Description	Signature/Stamp
3.1.1	Verify that the workspace has a clean assembly mat and anti-static mat, and that the cleaning record has been signed since last use.	Stamp or sign here
3.1.2	Verify that the HEPA fume extractor turns on, and you can feel air suction from the nozzle.	Stamp or sign here

continues on next page

Table 4 – continued from previous page

Step	Description	Signature/Stamp
3.1.3	Verify that the 5040-XTS rework station soldering iron tip is not worn down. If it is worn down, obtain a new 900M-T-I tip from the stores department.	Stamp or sign here
3.1.4	Verify that the heating surface of the MHP30 hot plate is clean.	Stamp or sign here

## 220 3.2 Project consumables

221 Obtain each of the below consumable items from the stores department:

Table 5: Assembly consumables

Item #	Description	Signature/Stamp
3.2.1	 <p>Fig. 2: 1 pair ESD gloves If you prefer to use your own pair of ESD gloves, make sure they are tested before use.</p>	Stamp or sign here
3.2.2	 <p>Fig. 3: 1 spool MG Chemicals 4900 Lead Free No-Clean Wire Solder Sn96.2Ag2.8Cu0.4 (96.2/2.8/0.4) 20 AWG</p>	Stamp or sign here

### 222 3.3 Project tools

- 223 Obtain a tools container labelled "1XXX Assembly Tools" from the 1XXX section of the stores supply shelf. At your assembly desk, use [Table 6](#) to verify that all the required tools are present.
- 224 If any required tools are missing, return all tools and the tools container to the stores department, and obtain another tools container.



Fig. 4: Tools Container

- 227 Remove each of the following tools from the tools container, and place them on the anti-static mat of the assembly desk:

Table 6: Assembly tools

Item #	Description	Signature/Stamp
3.3.1		Stamp or sign here

Fig. 5: Hozan F-23 components tray

continues on next page

Table 6 – continued from previous page

Item #	Description	Signature/Stamp
3.3.2	 Fig. 6: ESD tweezers	 Stamp or sign here
3.3.3	 Fig. 7: 3mm Phillips adjustable torque screwdriver	 Stamp or sign here
3.3.4	 Fig. 8: Fine-tipped Sharpie marker	 Stamp or sign here

continues on next page

Table 6 – continued from previous page

Item #	Description	Signature/Stamp
3.3.5	 Fig. 9: Scissors	Stamp or sign here

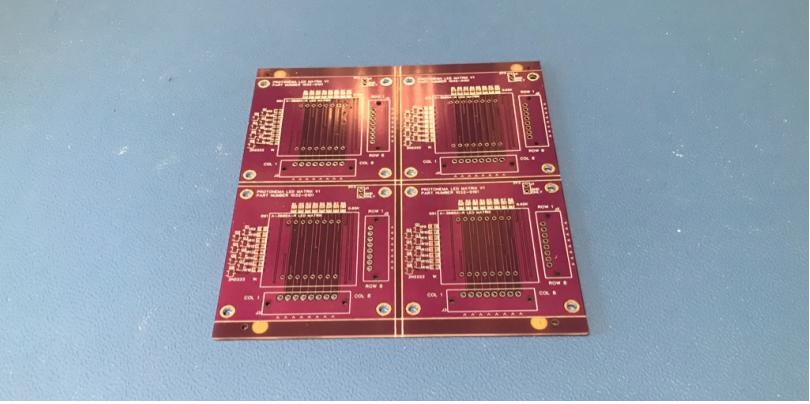
229 **3.4 Parts preparation**

230 **3.4.1 PCBs and PCBAs**

231 NOTICE: All PCBs and PCBAs must be handled with gloves to prevent marking with skin oils.

232 NOTICE: PCBs are removed from manufacturer packaging only when needed.

Table 7: PCBs and PCBAs

Item #	Description	Signature/Stamp
3.4.1.1	No marking required  Fig. 10: 1x 1032-0101 v1.0 - LED Matrix Stamp PCB	Stamp or sign here

### 233 3.4.2 Reel cuttings

- 234 All reels are stored in the bin labelled "1XXX Reels" on the shelf labelled "1XXX Components". As this is a manually  
 235 assembled product (no automated pick-and-place), tape should be cut off as needed for the number of units being  
 236 assembled, and placed in the assembly tray.



Fig. 11: Reels Container

- 237 Cut off the indicated number of parts (multiplied by the number of units to be assembled), and mark them with the  
 238 value:

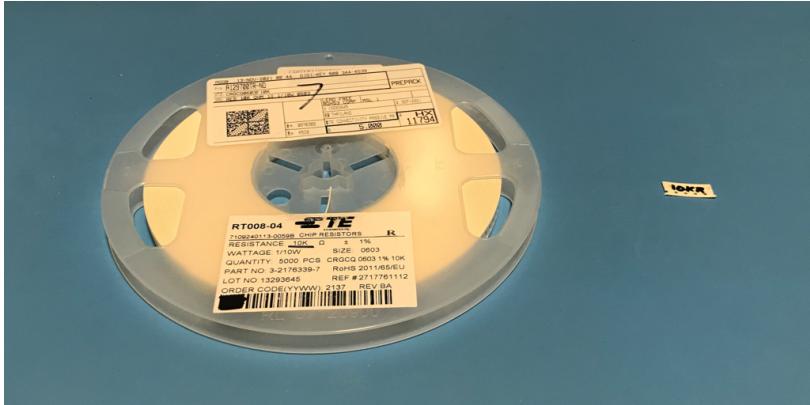
Table 8: Assembly reels

Reel #	Description	Signature/Stamp
1	<p>Mark with "649R"</p>	<p>Stamp or sign here</p>

Fig. 12: 8x 649 Ohm 0603 resistors

continues on next page

Table 8 – continued from previous page

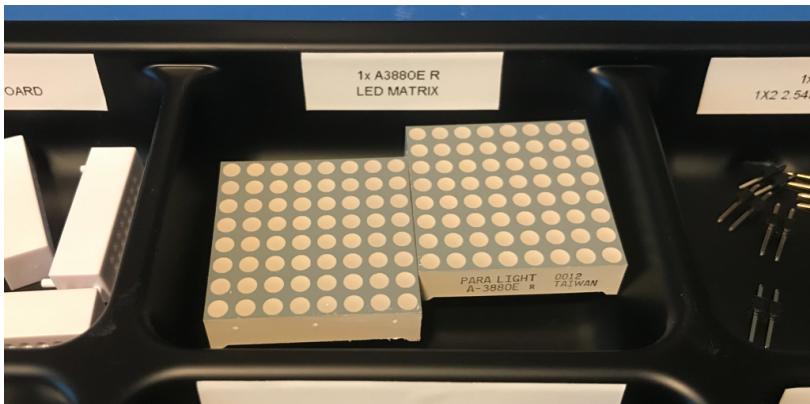
Reel #	Description	Signature/Stamp
7	Mark with "10KR"  	Stamp or sign here
17	No marking required  	Stamp or sign here

<sup>239</sup> Be sure to return the 1XXX Reels bin as soon as you have finished cutting off the required parts.

### 240 3.4.3 Loose components

241 All loose components are stored on the shelf labelled "1XXX Components". Take the components tray and obtain  
 242 the following quantities of the following parts:

Table 9: Loose components

Item #	Description	Signature/Stamp
3.4.3.1	No marking required    Fig. 15: 1x ZY28 - 16 Point solderless breadboard	Stamp or sign here
3.4.3.2	No marking required    Fig. 16: 1x A3880E - LED matrix display	Stamp or sign here
3.4.3.3	No marking required    Fig. 17: 1x 0022284020 - 1x2 2.54mm Male Header	Stamp or sign here

continues on next page

Table 9 – continued from previous page

Item #	Description	Signature/Stamp
3.4.3.4	<p>No marking required</p> 	<p>Stamp or sign here</p>
3.4.3.5	<p>No marking required</p> 	<p>Stamp or sign here</p>
3.4.3.6	<p>No marking required</p> 	<p>Stamp or sign here</p>

Fig. 18: 4x 5mm M3 Nylon Screws

Fig. 19: 4x M3 11mm+6 Black Nylon Standoffs

Fig. 20: 4x M3 Black Nylon Nuts

### 243 3.4.4 Packaging materials

- 244 All packaging materials are stored on the shelf labelled "1XXX Components". Take the packaging box and obtain  
245 the following quantities of the following materials:

Table 10: Packaging materials

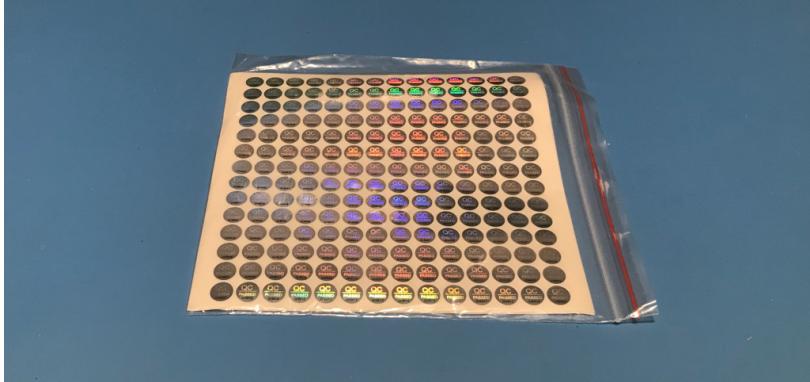
Item #	Description	Signature/Stamp
3.4.4.1	No marking required 	Stamp or sign here
3.4.4.2	No marking required 	Stamp or sign here
3.4.4.3	No marking required 	Stamp or sign here

Fig. 21: 1x QC Sticker

continues on next page

Table 10 – continued from previous page

Item #	Description	Signature/Stamp
3.4.4.4	No marking required 	Stamp or sign here
3.4.4.5	No marking required 	Stamp or sign here
3.4.4.6	No marking required 	Stamp or sign here

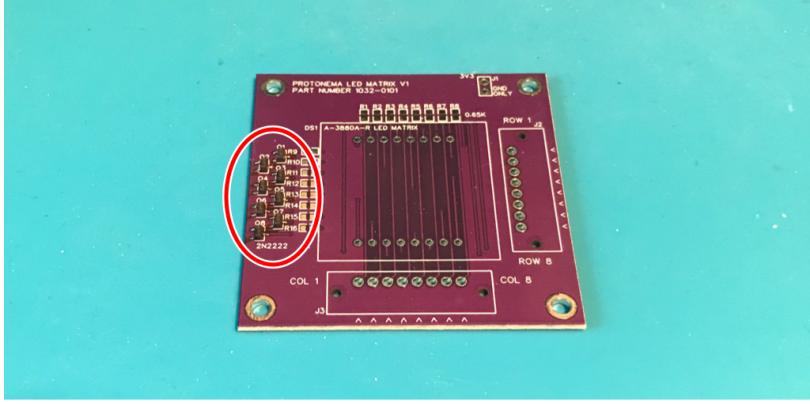
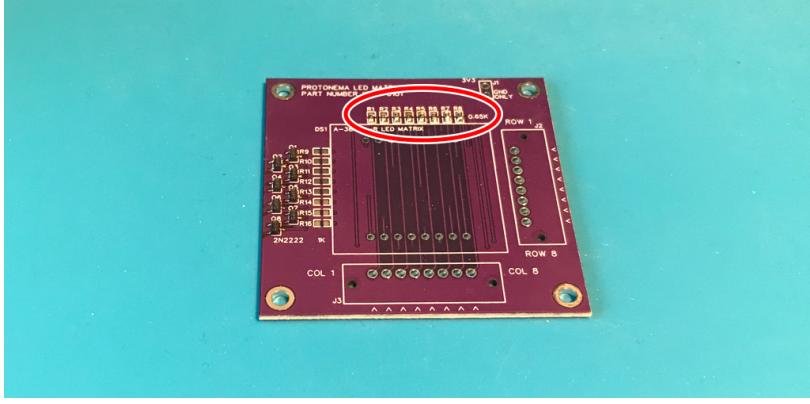
## 246 Section 4

# 247 Assembly

### 248 4.1 1032A assembly

249 This assembly step takes 5 minutes.

Table 11: 1032A assembly steps

Step #	Description	Signature/Stamp
4.1	Solder Q1 through Q8 onto the 1032-0101 PCB.  	Stamp or sign here
4.2	Solder R1 through R8 onto the 1032-0101 PCB.  	Stamp or sign here

continues on next page

Table 11 – continued from previous page

Step #	Description	Signature/Stamp
4.3	Solder R9 through R16 onto the 1032-0101 PCB.	Stamp or sign here
4.4	Insert the 2 pin header into J1 from the rear of the board, flip the board, and solder one pin of the header on, flip the board again and sure it is 90 degrees to the board, then solder the remaining pin.	Stamp or sign here
4.5	Insert the A3880E display module with the part number label facing down. Flip the board, and solder the display connectors, making sure that the display module pins are consistently at the top of the through holes.	Stamp or sign here

Fig. 29: 1032-0101 PCB with R9-R16 soldered on.

continues on next page

Table 11 – continued from previous page

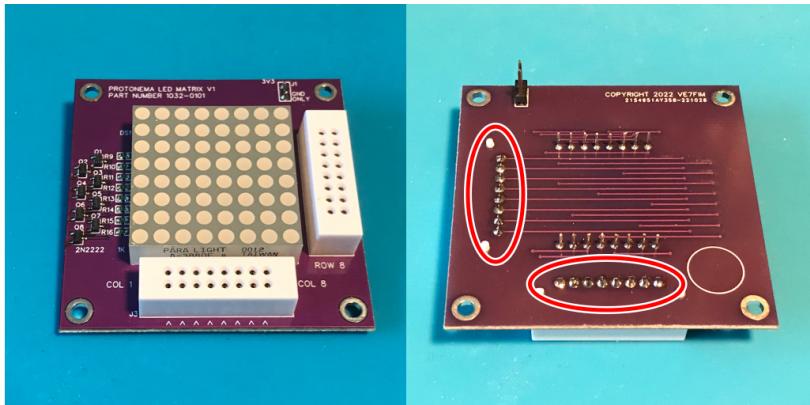
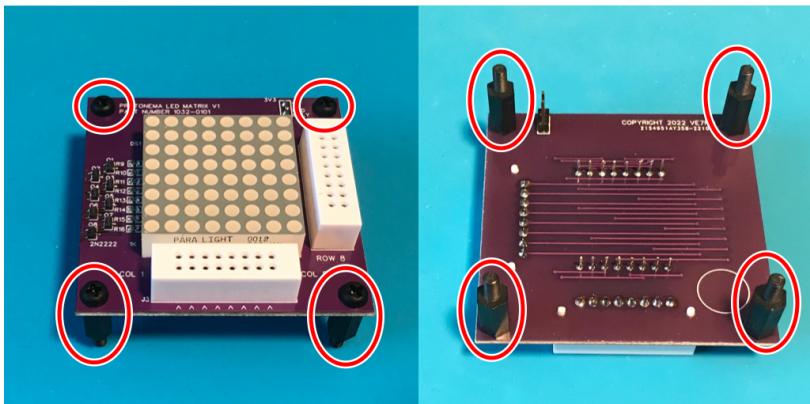
Step #	Description	Signature/Stamp
4.6	Insert the two breadboard modules, then solder.	
4.7	<p>For each of the four corner holes, attach a nylon screw to a nylon post through the hole.</p>  	

Fig. 32: 1032-0101 PCB with the two breadboard modules soldered on.

Fig. 33: 1032-0101 PCB with four nylon posts attached.

250 **Section 5**

251 **Test**

252 **5.1 Visual inspection**

253 This test process takes 2 minutes.

Table 12: 1032A visual inspection

Step #	Description	Signature/Stamp
1	Verify that there are no loose parts.	Stamp or sign here
2	Verify that there are no visible fingerprints.	Stamp or sign here

## 254 5.2 QC final check

255 This test process takes 2 minutes.

Table 13: 1032A QC final check

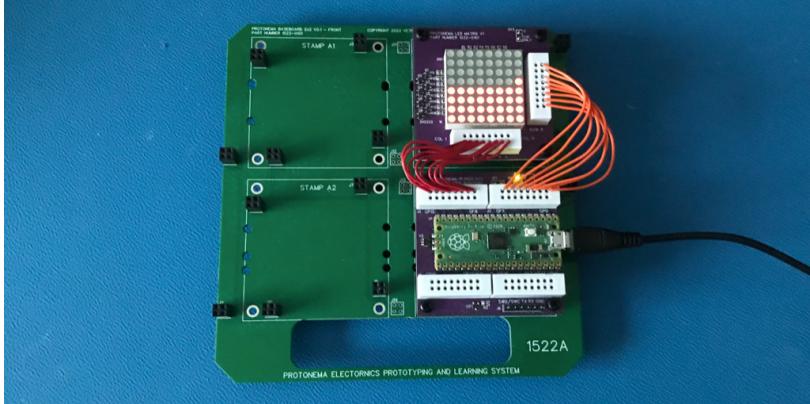
Step #	Description	Signature/Stamp
1	<p>Connect the 1032A to a baseboard and to a pre-programmed 1031A, as shown below. Connect power and verify that all of the LEDs light up in sequence.</p> <p>If test does not pass, write down the unexpected behaviour in the "Signature/Stamp" column on the right.</p> 	Stamp or sign here

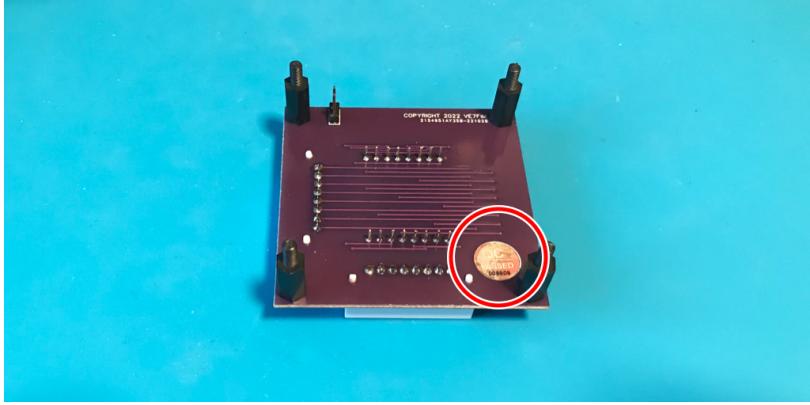
Fig. 34: Powered 1032-0101 PCB driven by a 1031A.

## 256 5.3 QC PASS

257 Only perform these steps if all QC checks have passed.

258 This test process takes 1 minutes.

Table 14: 1032A QC approval

Step #	Description	Signature/Stamp
1	<p>Using the tweezers, affix QC Passed sticker in location shown below, then write down the serial number from the QC sticker below the "Signature/Stamp" in the column to the right.</p> 	<div style="text-align: center; border: 1px solid gray; border-radius: 50%; width: 100px; height: 100px; margin: auto;"> <span>Stamp or sign here</span> </div>
2	<p>Take two photographs, one of the front of the 1032A, and one of the back of the 1032A.</p>	<div style="text-align: center; border: 1px solid gray; border-radius: 50%; width: 100px; height: 100px; margin: auto;"> <span>Stamp or sign here</span> </div>

259 5.4 QC FAIL

- 260 Only perform these steps if any QC check have failed.  
261 This test process takes 2 minutes.

Table 15: 1032A QC fail

Step #	Description	Signature/Stamp
1	<p>Place the 1032A module in the anti-static bag.</p> 	<p>Stamp or sign here</p>
2	<p>Take an A4 plastic bag, and place the 1032A, along with this document, in the “QC Fail” bin</p> <div style="text-align: center; margin-top: 20px;"> <span style="font-size: 2em;">FPO</span> </div>	<p>Stamp or sign here</p>

## **262 Section 6**

# **263 Packaging**

### **264 6.1 1032A packing**

**265 This packaging process takes 3 minutes.**

Table 16: 1032A packaging

Step #	Description	Signature/Stamp
6.1.1	Place the 1032A module in the anti-static bag.  	Stamp or sign here
6.1.2	Place four nylon nuts in a small anti-static bag, and add the bottom of the bag to the bag the 1032A module is in.  	Stamp or sign here

Fig. 38: 1032A in anti-static bag.

continues on next page

Table 16 – continued from previous page

Step #	Description	Signature/Stamp
6.1.3	Seal the anti-static bag with a 1032A sticker.	Stamp or sign here
		
	Fig. 40: 1028A in anti-static bag with sticker.	
6.1.4	Using the Sharpie pen, Write down the serial number of the 1032A on the sticker, at the end of the line listing the 1032A.	Stamp or sign here
		
	Fig. 41: Example photographs of the sealed bag with the serial number written on the sticker	
6.1.5	Place 1032A bag in the box on top of the bottom foam padding.	Stamp or sign here
		
	Fig. 42: 1032A in box.	
6.1.6	Take a photograph of the 1032A in the box.	Stamp or sign here

continues on next page

Table 16 – continued from previous page

Step #	Description	Signature/Stamp
6.1.7	Using the ESD tape, secure the lid of the box.  	Stamp or sign here
6.1.8	Affix a 1032A sticker to the lid of the box.  	Stamp or sign here
6.1.9	Using the Sharpie pen, Write down the serial number of the 1032A on the sticker, at the end of the line listing the 1032A.  	Stamp or sign here
6.1.10	Take a photograph of the sealed 1032A box.	Stamp or sign here

## **266 Section 7**

# **267 Clean-up**

### **268 7.1 Consumables**

**269** This packaging process takes 5 minutes.

Table 17: Consumables cleanup

Step #	Description	Signature/Stamp
1	If the ESD gloves have contacted solder paste, or are soiled, they shall be disposed of in the standard waste bin.	Stamp or sign here
2	If there is unused solder wire on the spool, it shall be returned to stores.	Stamp or sign here
3	Loose component packaging shall be disposed of in the standard waste bin.	Stamp or sign here

### **270 7.2 Tools**

**271** This cleanup process takes 5 minutes.

Table 18: Tools cleanup

Step #	Description	Signature/Stamp
1	All tools shall be returned to the assembly tools container, and returned to the stores supply shelf.  If any tools are damaged or worn, return the container to stores, and let the manager know which tool is damaged or worn.	Stamp or sign here

continues on next page

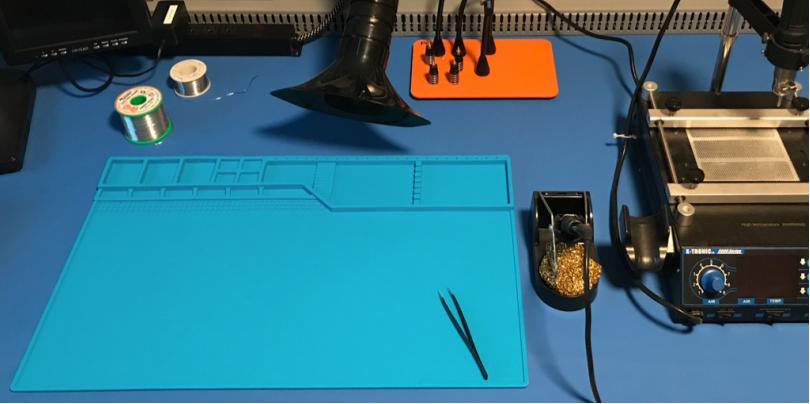
Table 18 – continued from previous page

Step #	Description	Signature/Stamp
2	Remove this document from the springback binder.	
3	Print a new copy of this document, and insert it into the springback binder that this document was originally in.	
4	Return the springback binder with the newly printed document to the 1032A section of the store supply shelf.	

## 272 7.3 Workspace

273 This packaging process takes 5 minutes.

Table 19: Workspace cleanup

Step #	Description	Signature/Stamp
1	<p>Make sure that the workspace is clean and as it was when you started the assembly.</p>  <p>Fig. 46: Clean assembly workstation</p>	Stamp or sign here

## **Section 8**

# **Record keeping**

### **8.1 1032A record keeping**

This packaging process takes 5 minutes.

Table 20: 1032A record keeping

Step #	Description	Signature/Stamp
1	<p>Write the serial number, the date, and your first and last name in large print on the bottom of the front cover of this document.</p> <div style="text-align: center; border: 1px solid black; padding: 10px; margin-top: 10px;"> <b>FPO</b> </div>	 <p>Stamp or sign here</p>
2	Create a new folder under the 1032A folder, named with the serial number.	 <p>Stamp or sign here</p>
3	Copy all photos taken during the assembly process into the newly created folder in step #2.	 <p>Stamp or sign here</p>
4	Remove this document from the binding clamps, scan the document, and save the scanned PDF into the newly created folder in step #2, with the name "1032A-SNAAAAAA.pdf", where AAAAAA is replaced with the serial number.	 <p>Stamp or sign here</p>

continues on next page

Table 20 – continued from previous page

Step #	Description	Signature/Stamp
5	Three-hole punch the document, then file it at the end of the current month's assembly records binder.	 Stamp or sign here
6	Add an entry to the assembly records binder, "<Date> - 1032A - SN# AAAAAAA - <Your Name>", where <Date> is replaced with today's date in ISO-8601 YYYY-MM-DD, where AAAAAAA is replaced with the serial number of the 1032A, and where <Your Name> is replaced with your first and last name.	 Stamp or sign here

278 **Section 9**

279 **Process improvement**

280 **9.1 Feedback**

281 Please submit an issue to the [Protonema Issue Repository](http://www.github.com/dslik/protonema/issues) (<http://www.github.com/dslik/protonema/issues>) if you  
282 encounter any of the below situations:

- 283 • Error in this document
- 284 • Unclear directions
- 285 • Suggested process improvements
- 286 • Results of QC failure investigations
- 287 • Tool change suggestions

288 Qualtiy processes and documentation is a team effort. This document would not exist without the participation and  
289 contributions of the entire assebly team.

290 Thank you for reading this assembly instructions document.

291 End of document.

292

## Part II

293

# 1032A Annexes

## 294 Section 10

### 295 Printed Circuit Boards

#### 296 10.1 1032-0101 PCB

Table 21: 1032-0101 PCB

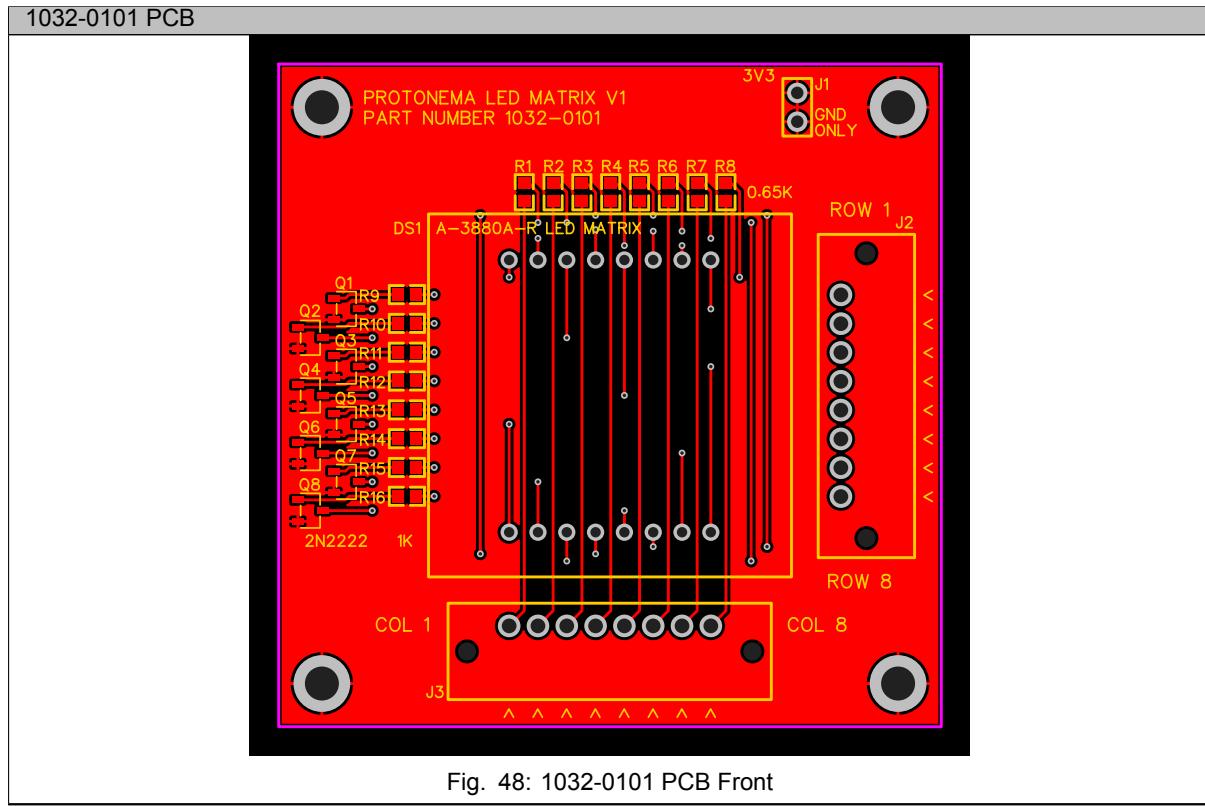
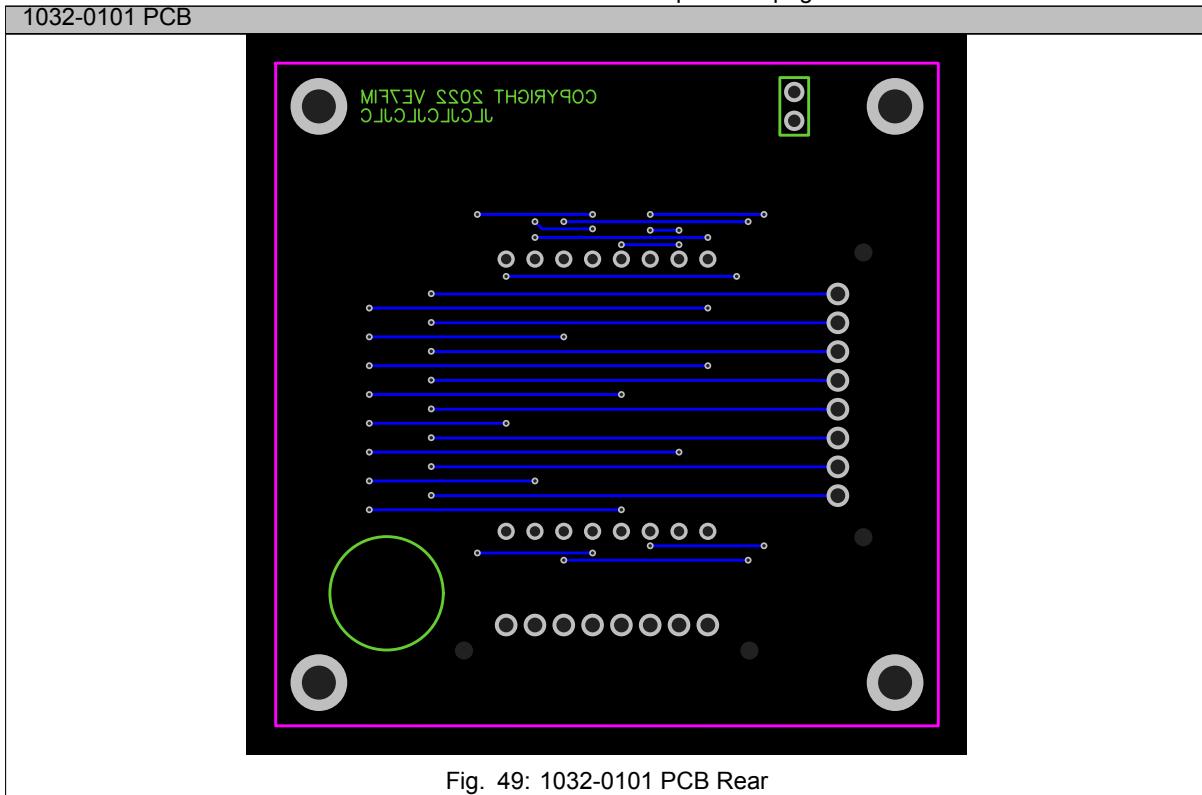


Fig. 48: 1032-0101 PCB Front

continues on next page

Table 21 – continued from previous page



## **297 Section 11**

# **298 Bill of materials**

### **299 11.1 1032A LED Matrix Stamp**

**300** The parts required to assemble a 1032A are listed in Table 22.

Table 22: 1032A parts

Reference Designation	Qty	Description	Manufacturer	Manufacturer Part Number	Supplier	Cost
1032-0101	1	Stamp PCB	JLCPCB	Y358-2154951A	JLCPCB	\$0.59 CAD
DS1	1	8x8 32mm LED Matrix Display	Paralight	A3880E	Tayda	\$1.82
J1	1	Connector Header Through Hole 2 position 0.100" (2.54mm)	Molex	0022284020	Digikey	\$0.17 CAD
J2, J3	2	16 Point solderless breadboard	Cixi Zhongyi Electronics Factory	ZY28	Zhongyi	\$2.54 CAD
R1 - R8	8	649 Ohms $\pm 1\%$ 0.1W, 1/10W Chip Resistor 0603 (1608 Metric)	Stackpole Electronics Inc	RMCF0603FT649R	Digikey	\$1.28 CAD
R9 - R16	8	10K Ohms $\pm 1\%$ 0.1W, 1/10W Chip Resistor 0603 (1608 Metric)	Stackpole Electronics Inc	RMCF0603FT10K0	Digikey	\$1.28 CAD
Q1 - Q8	8	Bipolar (BJT) Transistor NPN 40V 600mA SOT-23	Nexperia USA Inc.	MMBT2222A	Digikey	\$1.76 CAD
MP1 - MP4	4	Screw - M3 5mm Black Nylon Phillips Socket Button Head	Order By Description			\$0.25 CAD
MP5 - MP8	4	Standoff - M3 11mm+6 Black Nylon	Order By Description			\$0.30 CAD
MP9 - MP12	4	Nut - M3 Black Nylon	Order By Description			\$0.35 CAD
SK1	1	QC Sticker	Order by Description			\$0.0094 CAD
Total						\$10.35 CAD

## 301 11.2 1032A Packaging

302 The parts required to package a 1032A are listed in Table 23.

Table 23: 1032A packing parts

Reference Designation	Qty	Description	Manufacturer	Manufacturer Part Number	Supplier	Cost
N/A	1	Static Shielding Bag 4" X 4" Ziplock	SCS	30044	Digikey	\$0.22 CAD
N/A	1	Static Shielding Bag 1.5" X 2.8" Ziplock	Order by Description			\$0.06 CAD
N/A	1	CORREC-PAK SHIPPER 4 X 4 X 2" ID	Conductive Containers, Inc.	3631	Digikey	\$7.99 CAD
1032-7001	2	1032A ESD Sticker	Jukebox Print			\$4.00 CAD
Total						\$12.27 CAD

## **303    Section 12**

# **Reduction of Hazardous Materials**

**304**    Compliance declarations, in BOM order.

306 **12.1 MG Chemicals 4900**

Table 24: MG Chemicals 4900 RoHS Compliance

Declaration for MG Chemicals 4900 -  
<https://www.mgchemicals.com/downloads/msds/01%20English%20Can-USA%20SDS/sds-4900-4917.pdf>



**ISO 9001:2015 Quality Management System**  
 SAI Global File #004008  
 Burlington, Ontario, Canada

**SAC305 NO CLEAN SOLDER WIRE**

**4900-4917**

**California Proposition 65** (Chemicals known to cause cancer or reproductive toxicity, USA)

This product does not contain any of the listed substances.

**Europe**

**RoHS** (Restriction of Hazardous Substances Directive)

This product does not contain any lead, cadmium, mercury, hexavalent chromium, PBB's, PBDE's, DEHP, BBP, DBP, or DIBP and complies with European RoHS regulations.

**WEEE** (Waste Electrical and Electronic Equipment Directive)

This product is not a piece of electrical or electronics equipment, and is therefore not governed by this regulation.

**Section 16: Other Information**

**SDS Prepared by** MG Chemical's Regulatory Department

**Date of Review** 06 March 2020

**Supersedes** 09 July 2019

**Reason for Changes:** Update to the emergency phone number information.

**Reference**

1) ACGIH 2017 TLVs and BEIs: Based on the documentation of the threshold limit values for chemical substances and physical agents & biological exposure indices, American Conference of Governmental of Industrial Hygienist Cincinnati, OH (2017).

2) All toxicological data were checked against the RTECS (Registry of Toxic Effects of Chemical Substances®)

*Section continued on the next page*

Page **12 of 13**

Date of Revision: 06 March 2020 / Ver. 3.01

## 307 12.2 JLC lead-free PCB

Table 25: JLC PCB RoHS Compliance

Declaration for JLCPBCB lead-free PCBs - <https://s3.amazonaws.com/helpscout.net/docs/assets/59f1de7804286313cffbb22c/images/5d4d09562c7d3a036965d6a3/ROHS-Certificate-of-Compliance.jpg>

ROHS-Certificate-of-Compliance.jpg 566x800 pixels

2022-08-16, 23:45



<https://s3.amazonaws.com/helpscout.net/docs/assets/59f1de7804286313cffbb22c/images/5d4d09562c7d3a036965d6a3/ROHS-Certificate-of-Compliance.jpg>

Page 1 of 1

308 **12.3 PARALIGHT A3880E**

Table 26: PARALIGHT A3880E RoHS Compliance

Declaration for PARALIGHT A3880E - Received via e-mail

**Test Report**

No. SHAEC2210695901

Date: 30 Jul 2022

Page 1 of 10

Client Name : PARALIGHT LIANYUNGANG ELECTRONICS CO.,LTD.

Client Address : Economic Development Zone, Guannan County, Lianyungang City, Jiangsu Province

Sample Name : DISPLAY LED

The above sample(s) and information were provided by the client.

SGS Job No. : SP22-015593 - SH

Date of Sample Received : 25 Jul 2022

Testing Period : 25 Jul 2022 - 30 Jul 2022

Test Requested : Selected test(s) as requested by the client.

Test Method(s) : Please refer to next page(s).

Test Result(s) : Please refer to next page(s).

Conclusion : Based on the performed tests on submitted sample(s), the results of Cadmium, Lead, Mercury, Hexavalent chromium, Polybrominated biphenyls (PBBs), Polybrominated diphenyl ethers (PBDEs) and Phthalates such as Bis(2-ethylhexyl) phthalate (DEHP), Butyl benzyl phthalate (BBP), Dibutyl phthalate (DBP) and Diisobutyl phthalate (DIBP) comply with the limits as set by RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU.

Signed for and on behalf of  
SGS-CSTC Standards Technical Services (Shanghai) Co., Ltd.

Jenny Lan  
Approved Signatory



28646128



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Attention: To check the authenticity of testing /inspection report & certificate, please contact us at telephone: (86-755) 8307 1443, or email: [sales.sgs@sgs.com](mailto:sales.sgs@sgs.com).

3<sup>rd</sup> Building, No.889 Yizhan Road, Xuhui District, Shanghai China 200233 I E&E (86-21) 61402553 I E&E (86-21) 64953679 [www.sgsgroup.com.cn](http://www.sgsgroup.com.cn)

中国·上海·徐汇区宜山路889号3号楼 邮编: 200233 I HL (86-21) 61402594 I HL (86-21) 61156899 [e.sgs.china@sgs.com](mailto:e.sgs.china@sgs.com)

Member of the SGS Group (SGS SA)

309 **12.4 Molex 0022284020**

Table 27: Molex 0022284020 RoHS Compliance

Declaration for Molex 0022284020 - [https://www.molex.com/datasheets/rohspdf/0022284020\\_rohs.pdf](https://www.molex.com/datasheets/rohspdf/0022284020_rohs.pdf)**RoHS Certificate of Compliance**

06/29/2022

Molex is committed to managing the use of chemical substances in accordance with governmental regulations, industry standards, and customer-specific requirements in order to protect the environment. For each part listed, this document provides:

- EU RoHS Compliance Status.** EU RoHS status is declared per Directive 2011/65/EU and its subsequent amendments, including the Directive EU 2015/863 which additionally prohibited four phthalates. Homogeneous materials of parts that are compliant to this legislation have less than 0.1% by weight each of lead, mercury, hexavalent chromium, PBB, PBDE, DBP, BBP, DIBP, DEHP, and 0.01% by weight of cadmium. In situations where an exemption applies, the preceding limits, corresponding to the exempted substance(s), may be higher.

Molex's sole liability for incorrectly certifying a product shall be either replacement of the Molex product or, alternatively and in the sole discretion of Molex, return of the purchase price paid for the relevant Molex product.

For additional information regarding Molex's environmental initiatives and further explanation of this information, please visit [www.molex.com](http://www.molex.com)

Haim Eliyahu  
Director, Global Product Stewardship

**Table A**

Molex Part Number	Part Description	RoHS Compliance Status
0022284020	KK 254 Breakaway Header, Vertical, 2 Circuits, Tin (Sn) Plating, Mating Pin Length 6.09mm	Compliant

310 **12.5 Cixi ZY28**

Table 28: Cixi ZY28 Compliance

Declaration for Cixi ZY28 -  
<http://27696974.s21i.faiusr.com/2/ABUIABACGAAghLXJiwYogKav1QYwoAY46wg.jpg>

**Certificate of Compliance**

**Certificate Number:** BSTDG190612860702CC

<b>Applicant</b>	: CIXI ZHONGYI ELECTRONICS FACTORY Yuxiang Road, Xiaolin Town 315321 Cixi City Zhejiang Province China
<b>Manufacturer</b>	: CIXI ZHONGYI ELECTRONICS FACTORY Yuxiang Road, Xiaolin Town 315321 Cixi City Zhejiang Province China
<b>Product Name</b>	: BREAD BOARD
<b>Test Standard</b>	: IEC 62321-4:2013+AMD1:2017, IEC 62321-5:2013, IEC 62321-6:2015, IEC 62321-7-1:2015, IEC 62321-7-2:2017, IEC 62321-8:2017
<b>As shown in the Test Report No.</b>	: BSTDG190612860702CR

The EUT described above has been tested by us and found in compliance with the council RoHS 2 Directive 2011/65/EU Annex II (EU) 2015/863 as last amended by Directive (EU) 2017/2102. This certificate is only valid in conjunction with the test report.

**RoHS**

Tony Qian  
Approved Signatory  
Jun.10, 2019

**Dongguan BST Testing Co., Ltd**  
Add: A1201-1204 Xinsanqi of Dongbao Road, Dongcheng District, Dongguan, Guangdong, China  
Certificate Search: <http://www bst-lab.com>, Tel: 400-8829628, 800-9990305, E-mail: christina@bst-lab.com

311 **12.6 Stackpole RMCF0603FT10K0**

Table 29: Stackpole RMCF0603FT10K0 RoHS Compliance

Declaration for Stackpole RMCF0603FT10K0 -  
[https://www.seiselect.com/catalog/SEI-RoHS\\_Compliance\\_Status.pdf](https://www.seiselect.com/catalog/SEI-RoHS_Compliance_Status.pdf)



Resistors						
Standard Product Series	Description	Package / Termination Type	Standard Series RoHS Compliant	Lead-Free Termination Composition	Lead-Free Mfg. Effective Date (Std Product Series)	Lead-Free Effective Date Code (YY/WW)
NSP	Ceramic Housed - Consumer Grade Leaded Resistor <i>DISCONTINUED (May 3, 2013)</i>	Axial	YES	99.3/0.7 Sn/Cu	Jan-04	04/01
NSZ	Ceramic Housed Wirewound Resistor with Specialty Leads	Radial	YES	99.3/0.7 Sn/Cu	Jan-04	04/01
NVM	Ceramic Housed Vertical Mount Wirewound Resistor (Standard WW)	Radial	YES	100% Matte Sn	Always	Always
NWW	General Purpose and Precision Leaded Wirewound Resistor - Conformal Coated - Non-Inductive	Axial	YES	100% Matte Sn	Jan-06	06/01
PCB	Ceramic Housed Leaded Wirewound Resistor - PC Mount <i>DISCONTINUED (July 1, 2014)</i>	Radial	YES	100% Matte Sn	Always	Always
RACF	Thick Film Surface Mount Chip Resistor Array Concave Terminations <i>DISCONTINUED (Nov. 15, 2019)</i>	SMD	YES <sup>(1)</sup>	100% Matte Sn over Ni	Jan-04	04/01
RAF	Thick Film Surface Mount Chip Resistor Array Flat Terminations	SMD	YES <sup>(1)</sup>	100% Matte Sn over Ni	Jul-04	04/27
RAVF	Thick Film Surface Mount Chip Resistor Array Convex Terminations	SMD	YES <sup>(1)</sup>	100% Matte Sn over Ni	Jan-04 (Japan) Jul-04 (Taiwan)	04/01 04/27
RAVS	Convex Anti-Sulfur Chip Resistor Array	SMD	YES <sup>(1)</sup>	100% Matte Sn over Ni	Always	Always
RC	Carbon Composition Leaded Resistor	Axial	YES	100% Matte Sn	Jan-86	86/01
RGC	Semi-Precision Thick Film Surface Mount Resistor	SMD	YES <sup>(1)</sup>	100% Matte Sn over Ni	Jul-04	04/27
RHC	High Power Thick Film Surface Mount Chip Resistor	SMD	YES <sup>(1)</sup>	100% Matte Sn over Ni	Jul-04	04/27
RMCA	Automotive Grade Thick Film Chip Resistor	SMD	YES <sup>(1)</sup>	100% Matte Sn over Ni	Always	Always
RMCF	General Purpose Thick Film Surface Mount Chip Resistor	SMD	YES <sup>(1)</sup>	100% Matte Sn over Ni	Jan-04 (Japan) Jan-05 (Taiwan, China)	04/01 05/01
RMCG	Gold Barrier Thick Film Surface Mount Chip Resistor	SMD	YES <sup>(1)</sup>	100% Matte Sn over Ni	Jan-06	06/01
RMCP	General Purpose High Power Thick Film Chip Resistor	SMD	YES <sup>(1)</sup>	100% Matte Sn over Ni	Always	Always
RMCS	Sulfur Resistant Thick Film Surface Mount Chip Resistor	SMD	YES <sup>(1)</sup>	100% Matte Sn over Ni	Always	Always
RMCW	Wide Termination Thick Film Chip Resistor	SMD	YES <sup>(1)</sup>	100% Matte Sn over Ni	Always	Always
RMEF	General Purpose Thick Film Surface Mount Chip Resistor 100% Lead Free	SMD	YES	100% Mtte Sn over Ni	Always	Always
RNCF	Precision Thin Film Surface Mount Chip Resistor	SMD	YES	100% Matte Sn over Ni	May-04	04/18
RNCH	Anti-Corrosive Tantalum Nitride Replacement Surface Mount Chip Resistor	SMD	YES	100% Matte Sn over Ni	Always	Always
RNCP	High Power Anti-Sulfur Thin Film Chip Resistor	SMD	YES	100% Matte Sn over Ni	Always	Always
RNCS	Anti-Corrosive Tantalum Nitride Replacement Surface Mount Chip Resistor	SMD	YES	100% Matte Sn over Ni	May-04	04/18
RNCW	Thin Film Wire-Bondable Chip Resistor - <i>DISCONTINUED (Jan. 17, 2018)</i>	SMD	YES	Gold Plating	Always	Always
RNF	General Purpose Metal Film Leaded Resistor	Axial	YES	99.3/0.7 Sn/Cu 100% Matte Sn	Apr-05 (Japan) Jan-04 (Taiwan, China)	05/14 04/01
RNMF	General Purpose Mini Metal Film Leaded Resistor	Axial	YES	99.3/0.7 Sn/Cu 100% Matte Sn	Apr-05 (Japan) Jan-04 (Taiwan, China)	05/14 04/01
RNS	Ultra-Miniature Metal Film Resistor	Axial	YES	100% Matte Sn	Always	Always

Note (1): RoHS Compliant by means of exemption 7c-l.

Rev Date: 3/1/2022

3

[www.seiselect.com](http://www.seiselect.com)  
[marketing@seiselect.com](mailto:marketing@seiselect.com)

This specification may be changed at any time without prior notice.  
 Please confirm technical specifications before you order and/or use.

312 **12.7 Stackpole RMCF0603FT649R**

Table 30: Stackpole RMCF0603FT649R RoHS Compliance

Declaration for Stackpole RMCF0603FT649R -  
[https://www.seiselect.com/catalog/SEI-RoHS\\_Compliance\\_Status.pdf](https://www.seiselect.com/catalog/SEI-RoHS_Compliance_Status.pdf)



Resistors						
Standard Product Series	Description	Package / Termination Type	Standard Series RoHS Compliant	Lead-Free Termination Composition	Lead-Free Mfg. Effective Date (Std Product Series)	Lead-Free Effective Date Code (YY/WW)
NSP	Ceramic Housed - Consumer Grade Leaded Resistor <i>DISCONTINUED (May 3, 2013)</i>	Axial	YES	99.3/0.7 Sn/Cu	Jan-04	04/01
NSZ	Ceramic Housed Wirewound Resistor with Specialty Leads	Radial	YES	99.3/0.7 Sn/Cu	Jan-04	04/01
NVM	Ceramic Housed Vertical Mount Wirewound Resistor (Standard WW)	Radial	YES	100% Matte Sn	Always	Always
NWW	General Purpose and Precision Leaded Wirewound Resistor - Conformal Coated - Non-Inductive	Axial	YES	100% Matte Sn	Jan-06	06/01
PCB	Ceramic Housed Leaded Wirewound Resistor - PC Mount <i>DISCONTINUED (July 1, 2014)</i>	Radial	YES	100% Matte Sn	Always	Always
RACF	Thick Film Surface Mount Chip Resistor Array Concave Terminations <i>DISCONTINUED (Nov. 15, 2019)</i>	SMD	YES <sup>(1)</sup>	100% Matte Sn over Ni	Jan-04	04/01
RAF	Thick Film Surface Mount Chip Resistor Array Flat Terminations	SMD	YES <sup>(1)</sup>	100% Matte Sn over Ni	Jul-04	04/27
RAVF	Thick Film Surface Mount Chip Resistor Array Convex Terminations	SMD	YES <sup>(1)</sup>	100% Matte Sn over Ni	Jan-04 (Japan) Jul-04 (Taiwan)	04/01 04/27
RAVS	Convex Anti-Sulfur Chip Resistor Array	SMD	YES <sup>(1)</sup>	100% Matte Sn over Ni	Always	Always
RC	Carbon Composition Leaded Resistor	Axial	YES	100% Matte Sn	Jan-86	86/01
RGC	Semi-Precision Thick Film Surface Mount Resistor	SMD	YES <sup>(1)</sup>	100% Matte Sn over Ni	Jul-04	04/27
RHC	High Power Thick Film Surface Mount Chip Resistor	SMD	YES <sup>(1)</sup>	100% Matte Sn over Ni	Jul-04	04/27
RMCA	Automotive Grade Thick Film Chip Resistor	SMD	YES <sup>(1)</sup>	100% Matte Sn over Ni	Always	Always
RMCF	General Purpose Thick Film Surface Mount Chip Resistor	SMD	YES <sup>(1)</sup>	100% Matte Sn over Ni	Jan-04 (Japan) Jan-05 (Taiwan, China)	04/01 05/01
RMCG	Gold Barrier Thick Film Surface Mount Chip Resistor	SMD	YES <sup>(1)</sup>	100% Matte Sn over Ni	Jan-06	06/01
RMCP	General Purpose High Power Thick Film Chip Resistor	SMD	YES <sup>(1)</sup>	100% Matte Sn over Ni	Always	Always
RMCS	Sulfur Resistant Thick Film Surface Mount Chip Resistor	SMD	YES <sup>(1)</sup>	100% Matte Sn over Ni	Always	Always
RMCW	Wide Termination Thick Film Chip Resistor	SMD	YES <sup>(1)</sup>	100% Matte Sn over Ni	Always	Always
RMEF	General Purpose Thick Film Surface Mount Chip Resistor 100% Lead Free	SMD	YES	100% Mtte Sn over Ni	Always	Always
RNCF	Precision Thin Film Surface Mount Chip Resistor	SMD	YES	100% Matte Sn over Ni	May-04	04/18
RNCH	Anti-Corrosive Tantalum Nitride Replacement Surface Mount Chip Resistor	SMD	YES	100% Matte Sn over Ni	Always	Always
RNCP	High Power Anti-Sulfur Thin Film Chip Resistor	SMD	YES	100% Matte Sn over Ni	Always	Always
RNCS	Anti-Corrosive Tantalum Nitride Replacement Surface Mount Chip Resistor	SMD	YES	100% Matte Sn over Ni	May-04	04/18
RNCW	Thin Film Wire-Bondable Chip Resistor - <i>DISCONTINUED (Jan. 17, 2018)</i>	SMD	YES	Gold Plating	Always	Always
RNF	General Purpose Metal Film Leaded Resistor	Axial	YES	99.3/0.7 Sn/Cu 100% Matte Sn	Apr-05 (Japan) Jan-04 (Taiwan, China)	05/14 04/01
RNMF	General Purpose Mini Metal Film Leaded Resistor	Axial	YES	99.3/0.7 Sn/Cu 100% Matte Sn	Apr-05 (Japan) Jan-04 (Taiwan, China)	05/14 04/01
RNS	Ultra-Miniature Metal Film Resistor	Axial	YES	100% Matte Sn	Always	Always

Note (1): RoHS Compliant by means of exemption 7c-l.

Rev Date: 3/1/2022

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[www.seiselect.com](http://www.seiselect.com)  
[marketing@seiselect.com](mailto:marketing@seiselect.com)

This specification may be changed at any time without prior notice.  
 Please confirm technical specifications before you order and/or use.

## 313 12.8 Nexperia MMBT2222A

Table 31: Nexperia MMBT2222A RoHS Compliance

Declaration for Nexperia MMBT2222A - <https://www.nexperia.com/dam/jcr:96c06925-615d-4095-b779-3718c9f9cdde/Nexperia%20-%20Statement%20on%20RoHS.pdf>



July 2022

### CERTIFICATE OF COMPLIANCE - RoHS Declaration -

Nexperia B.V. declares that its semiconductor products (including homogeneous sub-components, pins, casing, and internal parts) are designed to be:

RoHS compliant by meeting the requirements defined under Directive 2011/65/EU of 2011-07-21, amended by Directive (EU) 2015/863 of 2015-03-31, on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE):

RoHS Restricted Substance	Allowable Limit
Cadmium (Cd)	100 ppm (0.01 weight %)
Mercury (Hg)	1000 ppm (0.1 weight %)
Hexavalent chromium (Cr <sup>6+</sup> )	1000 ppm (0.1 weight %)
Lead (Pb)	1000 ppm (0.1 weight %)
Polybrominated biphenyls (PBBs)	1000 ppm (0.1 weight %)
Polybrominated diphenyl ethers (PBDEs)*	1000 ppm (0.1 weight %)
Bis(2-ethylhexyl) phthalate (DEHP)	1000 ppm (0.1 weight %)
Butyl benzyl phthalate (BBP)	1000 ppm (0.1 weight %)
Dibutyl phthalate (DBP)	1000 ppm (0.1 weight %)
Diisobutyl phthalate (DIBP)	1000 ppm (0.1 weight %)

\* Including decabromodiphenylether (decaBDE).

All Nexperia devices are RoHS compliant. Nexperia devices contain no more than 0.1 % lead (Pb) by weight per homogeneous material or may contain lead (Pb) in applications allowed by the RoHS Directive. Nexperia may apply any of the following RoHS exemptions to RoHS compliant Nexperia devices:

RoHS Exemption	RoHS Exemption Description
7(a)	Lead in high melting temperature type solders (i.e. lead-based alloys containing 85% by weight or more lead)
7(c)-I	Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectric devices, or in a glass or ceramic matrix compound

Nexperia devices can be recognized by the "RoHS compliant" logo on the box label. In addition, products that do not make use of any exemption on the use of lead can be recognized by the "Lead-free" logo.

To facilitate customer requirements and to verify Nexperia product compliance, Nexperia material content information is available here:  
<https://www.nexperia.com/quality/download-multiple-product-compositions.html>

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[nexperia.com](http://nexperia.com)

314 **12.9 M3 8mm Nylon Screw**

Table 32: M3 8mm Nylon Screw RoHS Compliance

Declaration for M3 8mm Nylon Screw - N/A
 <p>A photograph showing a clear plastic bag filled with numerous small, black, cylindrical M3 8mm Nylon Screws. A white rectangular label is pinned to the top center of the bag. The label contains the following text in Chinese:</p> <p>合格证 品名:尼龙螺丝 型号:十字M3*8 数量: 1000 材料: PA66 ROHS</p>

315 **12.10 M3 11mm Nylon Standoff**

Table 33: M3 11mm Nylon Standoff RoHS Compliance

Declaration for M3 11mm Nylon Standoff - N/A
 <p>合格证   PRODUCT QUALIFIED CARD</p> <p>产品名称: 六角隔柱</p> <p>规格型号: M3-11</p> <p>数 量: 1000 只</p> <p>检 验 员: _____</p> <p>材 质: PA66 ROHS</p>

316 **12.11 M3 Nylon Bolt**

Table 34: M3 Nylon Bolt RoHS Compliance

Declaration for M3 Nylon Bolt - N/A
<p>物料标签   PRODUCT QUALIFIED CARD</p> <p>产品名称: 六角螺帽</p> <p>规格型号: M3</p> <p>数    量: 1000 只</p> <p>产品编码: Z05BK0201/0775/0000/M03</p> <p>材    质: PA66 ROHS</p> <p>2022.1.16</p>